## COMBINED DECLARATION AND POWER OF ATTORNEY

As the below named inventor, I hereby declare that:

the specification of which

My residence, post office address and citizenship are as stated below next to my name and that I believe I am an original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled

## THREE-DIMENSIONAL MEMORY STRUCTURE AND MANUFACTURING METHOD THEREOF

_X is attached hereto					
was filed on					
as Application Se	rial No	and was amended on_	and was amended on		
specification, including I acknowledge th application in accordan I hereby claim for application(s) for pater	the claims, as amended e duty to disclose info ce with Title 37, Code eign priority benefits un not or inventor's certificatent or inventor's cer med:	and understand the content ed by any amendment referre ormation which is material to of Federal Regulations, § 1. nder Title 35, United States C cate listed below and have tificate having a filing date be	d to above. the patent 56(a). ode, § 119 also identifi	ability of this of any foreign	
Number	Country	Date Filed(yyyy/mm/dd)	Yes	No	
	Taiwan, R.O.C.			X	
		30)		lication and to	
SEND CORRESPONDENCE TO:			DIRECT TELEPHONE CALLS TO: (Name and telephone number)		

Belinda Lee

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## P910238USD-09265

## COMBINED DECLARATION AND POWER OF ATTORNEY CONTINUED

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patents issued thereon.

Signature: Date: Ny, 21, 2005	Signature:	Erh - Kun	La:	Date: May, 21, 2003
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